

Zhi-Wen Lin

List of Publications by Year in descending order

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161
papers

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docs citations

162
times ranked

588
citing authors

#	ARTICLE	IF	CITATIONS
1	NTUplace3: An Analytical Placer for Large-Scale Mixed-Size Designs With Preplaced Blocks and Density Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 1228-1240.	1.9	260
2	Modern floorplanning based on B/sup */-tree and fast simulated annealing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2006, 25, 637-650.	1.9	104
3	BioRoute: A Network-Flow-Based Routing Algorithm for the Synthesis of Digital Microfluidic Biochips. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 1928-1941.	1.9	101
4	Analog Placement Based on Symmetry-Island Formulation. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2009, 28, 791-804.	1.9	75
5	Full-Chip Routing Considering Double-Via Insertion. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 844-857.	1.9	61
6	Obstacle-Avoiding Rectilinear Steiner Tree Construction Based on Spanning Graphs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 643-653.	1.9	60
7	Cross-Contamination Aware Design Methodology for Pin-Constrained Digital Microfluidic Biochips. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2011, 30, 817-828.	1.9	51
8	A Novel Layout Decomposition Algorithm for Triple Patterning Lithography. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2014, 33, 397-408.	1.9	50
9	Corner sequence - a P-admissible floorplan representation with a worst case linear-time packing scheme. IEEE Transactions on Very Large Scale Integration (VLSI) Systems, 2003, 11, 679-686.	2.1	48
10	TCG: A transitive closure graph-based representation for general floorplans. IEEE Transactions on Very Large Scale Integration (VLSI) Systems, 2005, 13, 288-292.	2.1	46
11	MR: a new framework for multilevel full-chip routing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2004, 23, 793-800.	1.9	44
12	TCG-S: Orthogonal Coupling of P^* -Admissible Representations for General Floorplans. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2004, 23, 968-980.	1.9	42
13	An Integer-Linear-Programming-Based Routing Algorithm for Flip-Chip Designs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2009, 28, 98-110.	1.9	42
14	Three-dimensional integrated circuits (3D IC) Floorplan and Power/Ground Network Co-synthesis. , 2010, , .		41
15	Temporal floorplanning using the T-tree formulation. , 0, , .		40
16	High-performance global routing with fast overflow reduction. , 2009, , .		38
17	Toward Optimal Legalization for Mixed-Cell-Height Circuit Designs. , 2017, , .		38
18	Crosstalk- and performance-driven multilevel full-chip routing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2005, 24, 869-878.	1.9	37

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19	MP-Trees: A Packing-Based Macro Placement Algorithm for Modern Mixed-Size Designs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 1621-1634.	1.9	37
20	NTUplace4dr: A Detailed-Routing-Driven Placer for Mixed-Size Circuit Designs With Technology and Region Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2018, 37, 669-681.	1.9	37
21	Essential Issues in Analytical Placement Algorithms. IPSJ Transactions on System LSI Design Methodology, 2009, 2, 145-166.	0.5	35
22	An effective legalization algorithm for mixed-cell-height standard cells. , 2017, , .		34
23	Recent research development and new challenges in analog layout synthesis. , 2016, , .		31
24	Timing modeling and optimization under the transmission line model. IEEE Transactions on Very Large Scale Integration (VLSI) Systems, 2004, 12, 28-41.	2.1	29
25	A New Multilevel Framework for Large-Scale Interconnect-Driven Floorplanning. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 286-294.	1.9	29
26	Thermal-Driven Analog Placement Considering Device Matching. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2011, 30, 325-336.	1.9	26
27	A Novel Wire-Density-Driven Full-Chip Routing System for CMP Variation Control. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2009, 28, 193-206.	1.9	24
28	ECO Timing Optimization Using Spare Cells and Technology Remapping. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2010, 29, 697-710.	1.9	24
29	Placement with symmetry constraints for analog layout design using TCG-S. , 0, , .		22
30	Multilayer Global Routing With Via and Wire Capacity Considerations. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2010, 29, 685-696.	1.9	22
31	Unified Analytical Global Placement for Large-Scale Mixed-Size Circuit Designs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2012, 31, 1366-1378.	1.9	21
32	Design-hierarchy aware mixed-size placement for routability optimization. , 2010, , .		19
33	Native-Conflict and Stitch-Aware Wire Perturbation for Double Patterning Technology. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2012, 31, 703-716.	1.9	19
34	Minimum-implant-area-aware detailed placement with spacing constraints. , 2016, , .		19
35	Multilevel Full-Chip Gridless Routing With Applications to Optical-Proximity Correction. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 1041-1053.	1.9	18
36	Power/Ground Network and Floorplan Cosynthesis for Fast Design Convergence. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 693-704.	1.9	17

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37	Native-conflict-aware wire perturbation for double patterning technology. , 2010, , .		17
38	Efficient and effective packing and analytical placement for large-scale heterogeneous FPGAs. , 2014, , .		17
39	Clock-Aware Placement for Large-Scale Heterogeneous FPGAs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2020, 39, 5042-5055.	1.9	17
40	Mixed-cell-height placement with complex minimum-implant-area constraints. , 2018, , .		16
41	Detailed-Routing-Driven analytical standard-cell placement. , 2015, , .		15
42	Detailed-routability-driven analytical placement for mixed-size designs with technology and region constraints. , 2015, , .		13
43	IMF: interconnect-driven multilevel floorplanning for large-scale building-module designs. , 0, , .		12
44	Metal-Density-Driven Placement for CMP Variation and Routability. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 2145-2155.	1.9	12
45	Recent research development in flip-chip routing. , 2010, , .		12
46	Predictive Formulae for OPC With Applications to Lithography-Friendly Routing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2010, 29, 40-50.	1.9	12
47	Fast Timing-Model Independent Buffered Clock-Tree Synthesis. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2012, 31, 1393-1404.	1.9	12
48	Circular-contour-based obstacle-aware macro placement. , 2016, , .		12
49	A novel damped-wave framework for macro placement. , 2017, , .		12
50	Mixed-cell-height legalization considering technology and region constraints. , 2018, , .		12
51	High variation-tolerant obstacle-avoiding clock mesh synthesis with symmetrical driving trees. , 2010, , .		11
52	TRECO: Dynamic Technology Remapping for Timing Engineering Change Orders. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2012, 31, 1723-1733.	1.9	11
53	Mixed-cell-height detailed placement considering complex minimum-implant-area constraints. , 2017, , .		11
54	Analytical Mixed-Cell-Height Legalization Considering Average and Maximum Movement Minimization. , 2019, , .		11

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55	A DAG-Based Algorithm for Obstacle-Aware Topology-Matching On-Track Bus Routing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2021, 40, 533-546.	1.9	11
56	Voltage Island Aware Floorplanning for Power and Timing Optimization. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2006, , .	0.0	10
57	Recent Research and Emerging Challenges in Physical Design for Manufacturability/Reliability. , 2007, , .		10
58	Multilevel Full-Chip Routing With Testability and Yield Enhancement. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 1625-1636.	1.9	10
59	Redundant-wires-aware ECO timing and mask cost optimization. , 2010, , .		10
60	An Efficient Pre-Assignment Routing Algorithm for Flip-Chip Designs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2012, 31, 878-889.	1.9	10
61	Cut redistribution with directed self-assembly templates for advanced 1-D gridded layouts. , 2016, , .		10
62	Mixed-cell-height placement considering drain-to-drain abutment. , 2018, , .		10
63	RLC effects on worst-case switching pattern for on-chip buses. , 0, , .		9
64	Clock-aware placement for large-scale heterogeneous FPGAs. , 2017, , .		9
65	Mixed-Cell-Height Detailed Placement Considering Complex Minimum-Implant-Area Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2021, 40, 2128-2141.	1.9	9
66	Mixed-Cell-Height Legalization Considering Technology and Region Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2020, 39, 5128-5141.	1.9	9
67	Simultaneous Floorplan and Buffer-Block Optimization. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2004, 23, 694-703.	1.9	8
68	An Optimal Jumper-Insertion Algorithm for Antenna Avoidance/Fixing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 1818-1829.	1.9	8
69	An Optimal Network-Flow-Based Simultaneous Diode and Jumper Insertion Algorithm for Antenna Fixing. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 1055-1065.	1.9	8
70	Routing for manufacturability and reliability. IEEE Circuits and Systems Magazine, 2009, 9, 20-31.	2.6	8
71	Via-based Redistribution Layer Routing for InFO Packages with Irregular Pad Structures. , 2020, , .		8
72	A Provably Good Wavelength-Division-Multiplexing-Aware Clustering Algorithm for On-Chip Optical Routing. , 2020, , .		8

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73	A Progressive-ILP-Based Routing Algorithm for the Synthesis of Cross-Referencing Biochips. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2009, 28, 1295-1306.	1.9	7
74	Escape routing for staggered-pin-array PCBs. , 2011, , .		7
75	Fast lithographic mask optimization considering process variation. , 2014, , .		7
76	Fogging Effect Aware Placement in Electron Beam Lithography. , 2017, , .		7
77	A High-Quality Mixed-Size Analytical Placer Considering Preplaced Blocks and Density Constraints. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2006, , .	0.0	6
78	A SAT-based routing algorithm for cross-referencing biochips. , 2011, , .		6
79	BiG. , 2019, , .		6
80	Inductance Modeling for On-Chip Interconnects. Analog Integrated Circuits and Signal Processing, 2003, 35, 65-78.	0.9	5
81	A routing algorithm for flip-chip design. , 0, , .		5
82	Multilevel full-chip gridless routing considering optical proximity correction. , 0, , .		5
83	Novel full-chip gridless routing considering double-via insertion. Proceedings - Design Automation Conference, 2006, , .	0.0	5
84	An Exact Jumper-Insertion Algorithm for Antenna Violation Avoidance/Fixing Considering Routing Obstacles. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 719-733.	1.9	5
85	ECO timing optimization using spare cells. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2007, , .	0.0	5
86	Stitch-Aware Routing for Multiple E-Beam Lithography. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2015, 34, 471-482.	1.9	5
87	Non-stitch triple patterning-aware routing based on conflict graph pre-coloring. , 2015, , .		5
88	Graph-Based Logic Bit Slicing for Datapath-Aware Placement. , 2017, , .		5
89	Topological Structure and Physical Layout Codesign for Wavelength-Routed Optical Networks-on-Chip. , 2020, , .		5
90	Novel wire density driven full-chip routing for CMP variation control. , 2007, , .		4

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91	Unified analytical global placement for large-scale mixed-size circuit designs. , 2010, , .		4
92	PRICE: Power reduction by placement and clock-network co-synthesis for pulsed-latch designs. , 2011, , .		4
93	Voltage-Drop Aware Analytical Placement by Global Power Spreading for Mixed-Size Circuit Designs. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2011, 30, 1649-1662.	1.9	4
94	Efficient Multi-Layer Obstacle-Avoiding Region-to-Region Rectilinear Steiner Tree Construction. , 2018, , .		4
95	Time-Division Multiplexing Based System-Level FPGA Routing for Logic Verification. , 2020, , .		4
96	Analytical Placement Considering the Electron-Beam Fogging Effect. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2021, 40, 560-573.	1.9	4
97	Simultaneous Buffer-sizing and Wire-sizing for Clock Trees Based on Lagrangian Relaxation. VLSI Design, 2002, 15, 587-594.	0.5	4
98	VLSI Structure-aware Placement for Convolutional Neural Network Accelerator Units. , 2021, , .		4
99	High-Correlation 3D Routability Estimation for Congestion-guided Global Routing. , 2022, , .		4
100	Performance optimization by wire and buffer sizing under the transmission line model. , 0, , .		3
101	Simultaneous block and I/O buffer floorplanning for flip-chip design. , 0, , .		3
102	Efficient multi-layer obstacle-avoiding rectilinear steiner tree construction. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2007, , .	0.0	3
103	Effective Wire Models for X-Architecture Placement. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2008, 27, 654-658.	1.9	3
104	Constraint graph-based macro placement for modern mixed-size circuit designs. , 2008, , .		3
105	Heterogeneous B<sup>g&t;∗</sup>-trees for analog placement with symmetry and regularity considerations. , 2011, , .		3
106	An integrated-spreading-based macro-refining algorithm for large-scale mixed-size circuit designs. , 2017, , .		3
107	Generalized Augmented Lagrangian and Its Applications to VLSI Global Placement. , 2018, , .		3
108	An Efficient EPIST Algorithm for Global Placement with Non-Integer Multiple-Height Cells. , 2020, , .		3

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109	Mixed-Cell-Height Placement With Drain-to-Drain Abutment and Region Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, 41, 1103-1115.	1.9	3
110	Timing-Driven Placement for FPGAs with Heterogeneous Architectures and Clock Constraints. , 2021, , .		3
111	A Bridge-based Compression Algorithm for Topological Quantum Circuits. , 2021, , .		3
112	Simultaneous Pre- and Free-assignment Routing for Multiple Redistribution Layers with Irregular Vias. , 2021, , .		3
113	Hamiltonian Path Based Mixed-Cell-Height Legalization for Neighbor Diffusion Effect Mitigation. , 2020, , .		3
114	An algorithm for dynamically reconfigurable FPGA placement. , 0, , .		2
115	TCG-S: orthogonal coupling of P*-admissible representations for general floorplans. , 2002, , .		2
116	Simultaneous floorplanning and buffer block planning. , 0, , .		2
117	Placement of digital microfluidic biochips using the T-tree formulation. Proceedings - Design Automation Conference, 2006, , .	0.0	2
118	MBS ^{ast} -Tree: A Multilevel Floorplanner for Large-Scale Building-Module Design. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2007, 26, 1430-1444.	1.9	2
119	An ILP algorithm for post-floorplanning voltage-island generation considering power-network planning. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2007, , .	0.0	2
120	Template-mask design methodology for double patterning technology. , 2010, , .		2
121	Efficient provably good OPC modeling and its applications to interconnect optimization. , 2010, , .		2
122	Statistical thermal modeling and optimization considering leakage power variations. , 2012, , .		2
123	Layer minimization in escape routing for staggered-pin-array PCBs. , 2013, , .		2
124	Provably Good Max [€] Min- m -Neighbor-TSP-Based Subfield Scheduling for Electron-Beam Photomask Fabrication. IEEE Transactions on Very Large Scale Integration (VLSI) Systems, 2018, 26, 378-391.	2.1	2
125	Latch Clustering for Timing-Power Co-Optimization. , 2020, , .		2
126	Unified Redistribution Layer Routing for 2.5D IC Packages. , 2020, , .		2

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127	Topological Structure and Physical Layout Co-Design for Wavelength-Routed Optical Networks-on-Chip. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, 41, 2237-2249.	1.9	2
128	Timing-Aware Fill Insertions With Design-Rule and Density Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, 41, 3529-3542.	1.9	2
129	A fast crosstalk- and performance-driven multilevel routing system. , 2003, , .		1
130	Multilevel full-chip routing for the X-based architecture. , 2005, , .		1
131	Sensitivity-based multiple-Vt cell swapping for leakage power reduction. , 2008, , .		1
132	Blockage-avoiding buffered clock-tree synthesis for clock latency-range and skew minimization. , 2010, , .		1
133	Symmetrical buffered clock-tree synthesis with supply-voltage alignment. , 2013, , .		1
134	Two-Stage Neural Network Classifier for the Data Imbalance Problem with Application to Hotspot Detection. , 2021, , .		1
135	Mixed-Cell-Height Placement With Complex Minimum-Implant-Area Constraints. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, 41, 4639-4652.	1.9	1
136	A Row-Based Algorithm for Non-Integer Multiple-Cell-Height Placement. , 2021, , .		1
137	A novel framework for multilevel routing considering routability and performance. , 0, , .		0
138	Formulae for performance optimization and their applications to interconnect-driven floorplanning. , 0, , .		0
139	Noise-aware buffer planning for interconnect-driven floorplanning. , 0, , .		0
140	Multilevel floorplanning/placement for large-scale modules using B*-trees. , 0, , .		0
141	A reusable methodology for non-slicing floorplanning. , 0, , .		0
142	Multilevel routing with jumper insertion for antenna avoidance. , 0, , .		0
143	Layout techniques for on-chip interconnect inductance reduction. , 0, , .		0
144	An exact jumper insertion algorithm for antenna effect avoidance/fixing. , 2005, , .		0

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145	Reconfigurable Platform for Content Science Research. , 0, , .		0
146	IEEE standard 1500 compatible interconnect diagnosis for delay and crosstalk faults. , 0, , .		0
147	Current Path Analysis for Electrostatic Discharge Protection. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2006, , .	0.0	0
148	Inductance Extraction for General Interconnect Structures. , 0, , .		0
149	Thermal-Driven Interconnect Optimization by Simultaneous Gate and Wire Sizing. , 2006, , .		0
150	An Optimal Simultaneous Diode/Jumper Insertion Algorithm for Antenna Fixing. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2006, , .	0.0	0
151	An efficient algorithm for statistical circuit optimization using lagrangian relaxation. IEEE/ACM International Conference on Computer-Aided Design, Digest of Technical Papers, 2007, , .	0.0	0
152	3D Video Applications and Intelligent Video Surveillance Camera and its VLSI Design. , 2007, , .		0
153	Simultaneous EUV flare variation minimization and CMP control with coupling-aware dummification. , 2014, , .		0
154	An Interview With Professor Chenming Hu, Father of 3D Transistors. IEEE Design and Test, 2017, 34, 90-96.	1.1	0
155	Blockage-aware terminal propagation for placement wirelength minimization. , 2017, , .		0
156	Cut Redistribution With Directed-Self-Assembly Templates for Advanced 1-D Gridded Layouts. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2017, 36, 2066-2079.	1.9	0
157	DSA-Friendly Detailed Routing Considering Double Patterning and DSA Template Assignments. , 2018, , .		0
158	DSA-Compliant Routing for 2-D Patterns Using Block Copolymer Lithography. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2019, 38, 267-280.	1.9	0
159	Voronoi Diagram Based Heterogeneous Circuit Layout Centerline Extraction for Mask Verification. , 2022, , .		0
160	A Bridge-based Compression Algorithm for Topological Quantum Circuits. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, , 1-1.	1.9	0
161	Novel Proximal Group ADMM for Placement Considering Fogging and Proximity Effects. IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems, 2022, , 1-1.	1.9	0